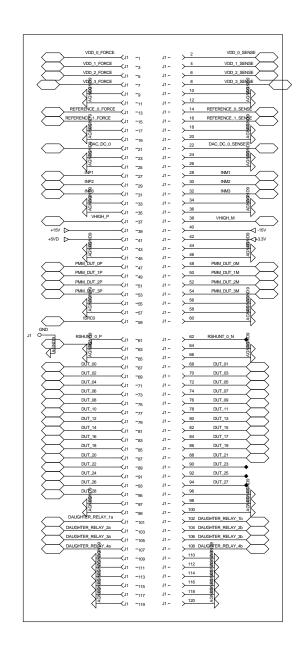
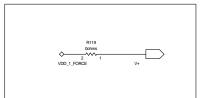


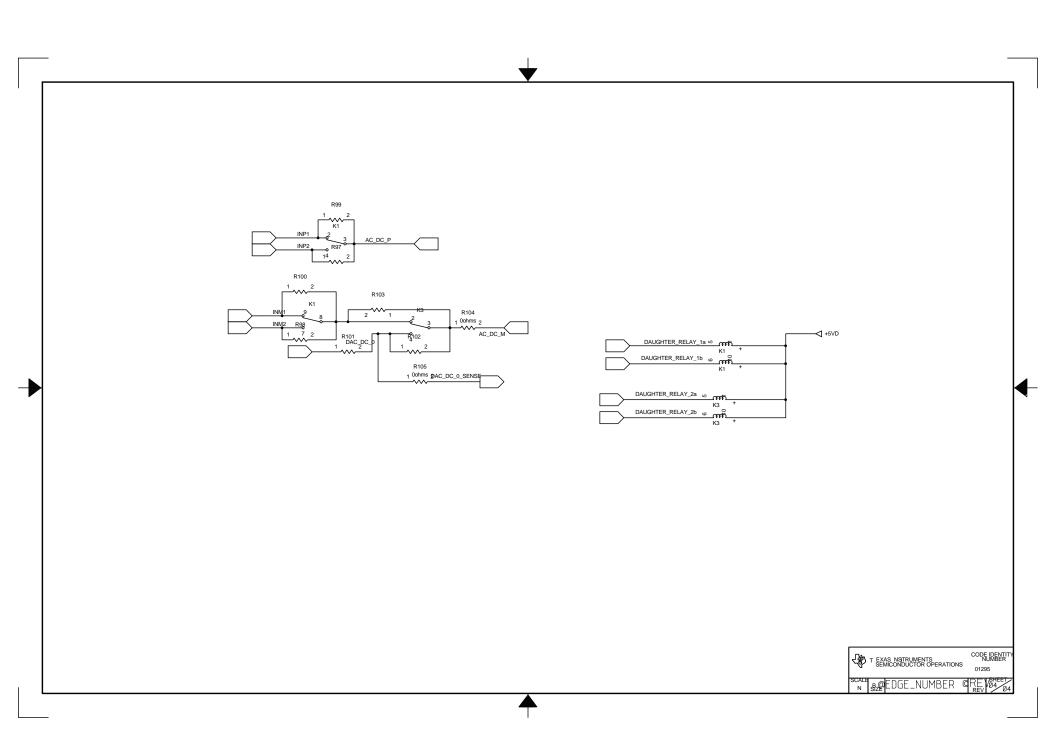
H=4ND; V=4LA



H=4ND: V=4LA



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